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Expertise Applied Answers Delivered

Title of Change:	Conversion from polarity notch to polarity band on SMC packaged products.	
Effective date:	9 March 2017	
Contact information:	Contact your local Littelfuse Sales Office	
Type of notification:	ON Semiconductor and Littelfuse will consider this change accepted.	
Change category:	Wafer Fab Change Assembly Change	X Marking Change Test Change Other
Change Sub-Category(s): Manufacturing Site Change Manufacturing Process Cha		 Datasheet/Product Doc change Shipping/Packaging/Marking Other:
Sites Affected:	pplicable ON Semiconductor site(s) : ON Seremban, Malaysia	External Foundry/Subcon site(s) Select Site
Description and Purpose: This product bulletin is announcing that ON Semiconductor Malaysia is converting the diode polarity identification for SMC packaged devices from a notch molded into the epoxy body of the device to a laser marked polarity band. The change will align ON Semiconductor Malaysia with the current industry standard for SMC polarity identification. The details of this change are displayed pictorially in Figure 1 below. An example device showing both the legacy notch that will be eliminated and the polarity band that will be replacing it is shown in Figure 2. Notch Design Polarity Bar Design both extend to edge of epoxy body SMC Package Top View SMC Package Top View		
Figure 1 Figure 2		Figure 2
During the transition period, both notches and the laser marked polarity band can be present within a same reel and packaging. As this change affects only external appearance, there is no product reliability and characterization testing required.		
List of affected Customer Specific Parts: Attached spreadsheet with table of part numbers		

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